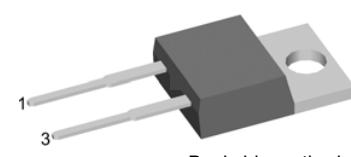
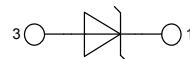


Schottky Diode

High Performance Schottky Diode
Low Loss and Soft Recovery
Single Diode

Part number

DSS25-0025B



Backside: cathode

Features / Advantages:

- Very low V_f
- Extremely low switching losses
- low I_{rm} values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package:

- Housing: TO-220
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

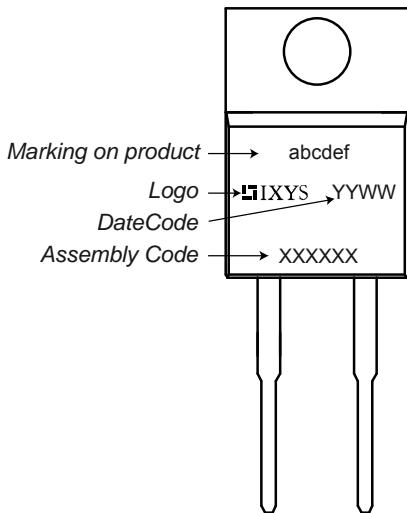
Ratings

Symbol	Definition	Conditions	min.	typ.	max.	Unit
V _{RRM}	max. repetitive reverse voltage	T _{vJ} = 25°C			25	V
I _R	reverse current	V _R = 25V T _{vJ} = 25°C		20	mA	
		V _R = 25V T _{vJ} = 100°C		80	mA	
V _F	forward voltage	I _F = 25A T _{vJ} = 25°C		0.52	V	
		I _F = 50A		0.67	V	
		I _F = 25A T _{vJ} = 125°C		0.45	V	
		I _F = 50A		0.66	V	
I _{FAV}	average forward current	rectangular, d = 0.5 T _C = 125°C		25	A	
V _{F0}	threshold voltage	T _{vJ} = 150°C		0.21	V	
r _F	slope resistance } for power loss calculation only			8.8	mΩ	
R _{thJC}	thermal resistance junction to case			1.40	K/W	
T _{vJ}	virtual junction temperature		-55	150	°C	
P _{tot}	total power dissipation	T _C = 25°C		90	W	
I _{FSM}	max. forward surge current	t = 10 ms (50 Hz), sine T _{vJ} = 45°C		330	A	
E _{AS}	non-repetitive avalanche energy	I _{AS} = 20 A; L = 100 μH T _{vJ} = 25°C		20	mJ	
I _{AR}	repetitive avalanche current	V _A = 1.5 · V _R typ.; f = 10 kHz		2	A	

Symbol	Definition	Conditions	Ratings		
			min.	typ.	max.
I_{RMS}	RMS current	per pin ¹⁾			35 A
R_{thCH}	thermal resistance case to heatsink			0.50	K/W
T_{stg}	storage temperature		-55		150 °C
Weight				2 g	
M_D	mounting torque		0.4		0.8 Nm
F_c	mounting force with clip		20		60 N

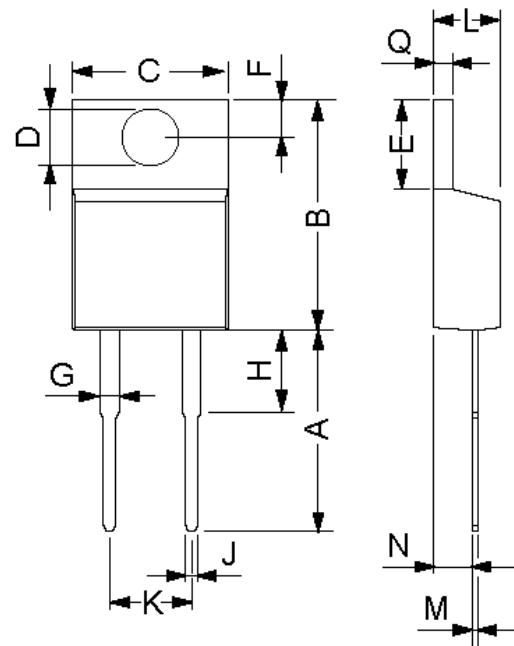
¹⁾ I_{RMS} is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.
In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

Product Marking



Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DSS25-0025B	DSS25-0025B	Tube	50	475114

Outlines TO-220



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	12.7	14.73	0.5	0.58
B	14.23	16.51	0.56	0.65
C	9.66	10.66	0.38	0.42
D	3.54	4.08	0.139	0.161
E	5.85	6.85	2.3	0.42
F	2.54	3.42	0.1	0.135
G	1.15	1.77	0.045	0.07
H	-	6.35	-	0.25
J	0.64	0.89	0.025	0.035
K	4.83	5.33	0.19	0.21
L	3.56	4.82	0.14	0.19
M	0.51	0.76	0.02	0.03
N	2.04	2.49	0.08	0.115
Q	0.64	1.39	0.025	0.055

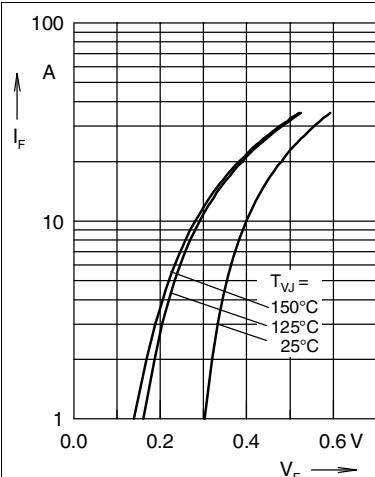


Fig. 1 Maximum forward voltage drop characteristics

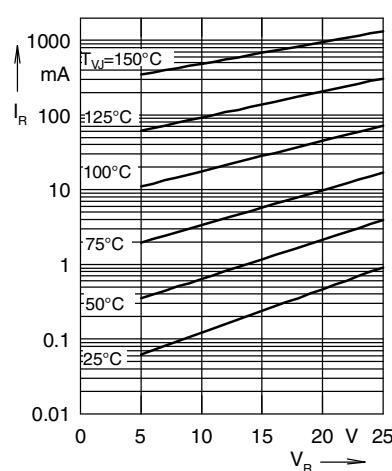
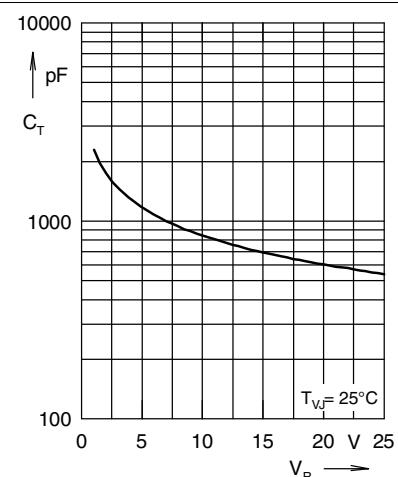
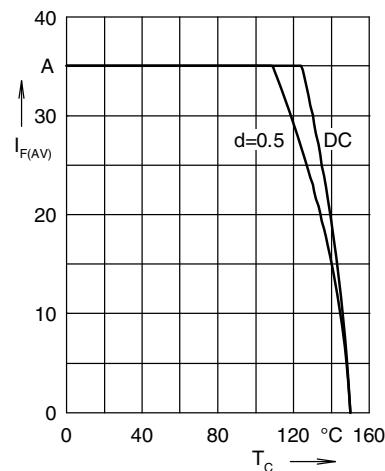
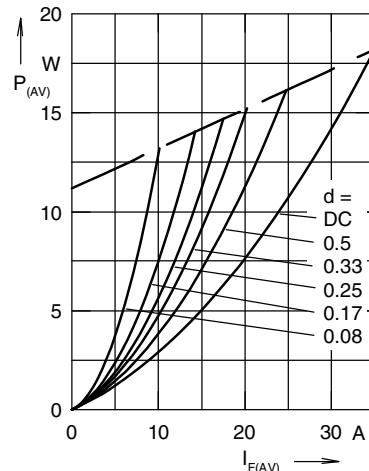
Fig. 2 Typ. value of reverse current I_R vs. reverse voltage V_R Fig. 3 Typ. junction capacitance C_T vs. reverse voltage V_R Fig. 4 Avg. forward current $I_{F(AV)}$ vs. case temperature T_C 

Fig. 5 Forward power loss characteristics

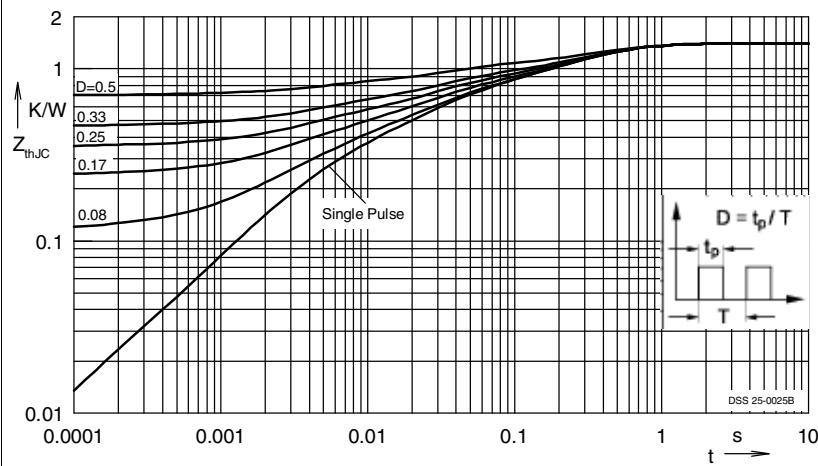


Fig. 6 Transient thermal impedance junction to case at various duty cycles

Note: All curves are per diode